

FDD390N15A N-Channel PowerTrench[®] MOSFET 150 V, 26 A, 40 m Ω

Features

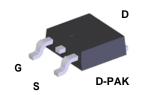
- $R_{DS(on)} = 33.5 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Fast Switching Speed
- Low Gate Charge, Q_G = 14.3 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

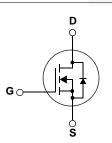
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Appliances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter	FDD390N15A	Unit		
V _{DSS}	Drain to Source Voltage		150	V		
V _{GSS}		- DC	- DC		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	v	
ID	Drain Current	- Continuous (T _C = 25°C,	- Continuous (T _C = 25 ^o C,Silicon Limited)		Α	
	Drain Current	- Continuous (T _C = 100°C	- Continuous (T _C = 100 ^o C,Silicon Limited)			
I _{DM}	Drain Current	- Pulsed	(Note 1)	104	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			78	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			6.0	V/ns	
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		63	W	
	Power Dissipation	- Derate above 25°C		0.5	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

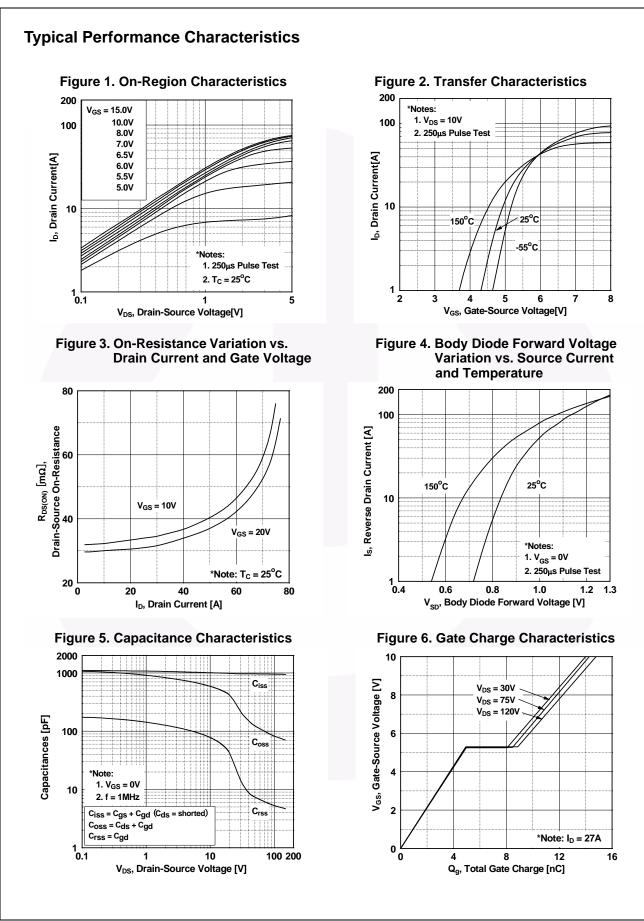
Thermal Characteristics

Symbol	Parameter	FDD390N15A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	87	°C/vv

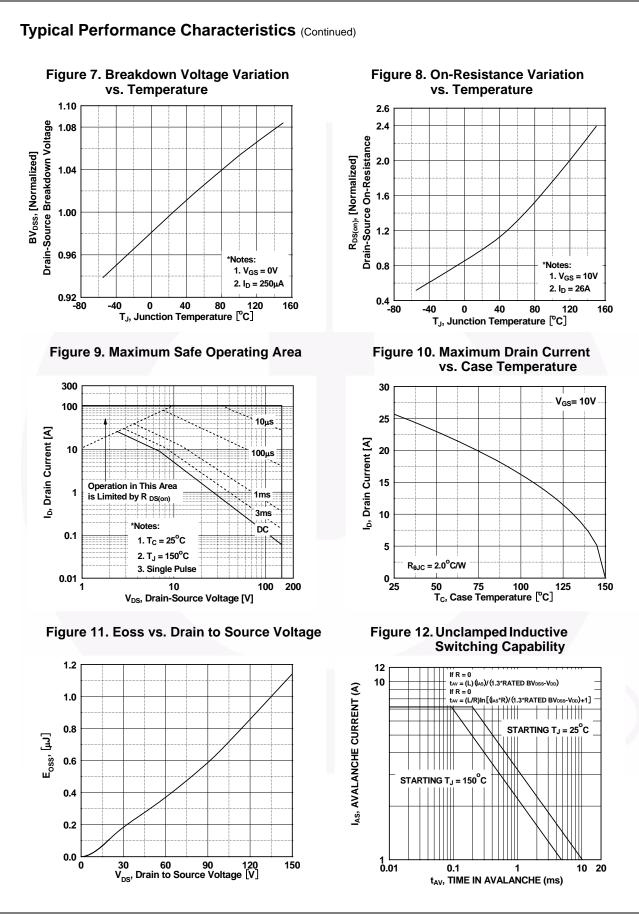
Part Nun	Part Number Top Mark Packa		Package	Packing Method	Reel Size	Tape W	/idth	Quantity	
FDD390N15A FDD390N15A DPAK		DPAK	Tape and Reel 330 mm		16 mm		2500 units		
Electrica	I Cha	racteristics T _c	= 25ºC unless	otherwise noted					
Symbol	Parameter			Test Conc	litions	Min.	Тур.	Max.	Unit
Off Charac	teristic	CS							
BV _{DSS}	Drain t	Drain to Source Breakdown Voltage		$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$		150	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		iture	$I_D = 250 \ \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$		-	0.1	-	V/ºC
	Zero G	ro Gato Voltago Drain Current		$\frac{V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 120 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}}$		-	-	1	μA
DSS	Zero Gate Voltage Drain Current		Tent			-	-	500	μΑ
I _{GSS}	Gate to	o Body Leakage Curre	nt	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristic	cs							
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250$	μA	2.0	-	4.0	V
R _{DS(on)}		Drain to Source On Re	esistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 26$		-	33.5	40	mΩ
9 _{FS}	Forwa	rd Transconductance		$V_{DS} = 10 \text{ V}, I_D = 26 \text{ A}$		-	33	-	S
Dynamic C	haract	eristics							
C _{iss}	-	Capacitance	-	V _{DS} = 75 V, V _{GS} = 0 V f = 1 MHz		-	965	1285	pF
C _{oss}	Output	Capacitance				-	96	130	pF
C _{rss}	Revers	se Transfer Capacitano	ce			-	5.8	-	pF
C _{oss(er)}	Energy Related Output Capacitance		icitance	V _{DS} = 75 V, V _{GS} = 0 V			169	-	pF
Q _{g(tot)}	Total G	Sate Charge at 10V		$V_{DS} = 75 \text{ V}, \text{ I}_{D} = 27 \text{ A}$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	14.3	18.6	nC
Q _{gs}	Gate to	o Source Gate Charge	1				5.0	-	nC
Q _{gs2}	Gate C	Charge Threshold to Pl	ateau			-	2.0	-	nC
Q _{gd}	Gate to	o Drain "Miller" Charge	;			-	3.5	-	nC
ESR	Equivalent Series Resistance (G-S)		∋ (G-S)	f = 1 MHz		-	1.4	-	Ω
Switching	Charad	cteristics							
d(on)	-	n Delay Time	-				14	38	ns
t _r	Turn-O	n Rise Time		V _{DD} = 75 V, I _D = 27		-	10	30	ns
t _{d(off)}	Turn-O	off Delay Time		V_{GS} = 10 V, R _{GEN} = 4.7 Ω (Note 4)		-	20	50	ns
t _f	Turn-O	off Fall Time				-	5	20	ns
Drain-Sou	rce Dio	de Characteristi							
s		um Continuous Drain t		e Forward Current		-	_	26	A
s sм	Maximum Pulsed Drain to Source Diode Fo					-	-	104	Α
V _{SD}	Drain to Source Diode Forward Voltage		$V_{GS} = 0 V, I_{SD} = 26 A$		-	- 7	1.25	V	
t _{rr}	Reverse Recovery Time		$V_{GS} = 0 V, I_{SD} = 27 A, V_{DD} = 75 V$ $dI_F/dt = 100 A/\mu s$		-	63	-	ns	
Q _{rr}	Reverse Recovery Charge				-	131	-	nC	

3. I_{SD} \leq 26 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

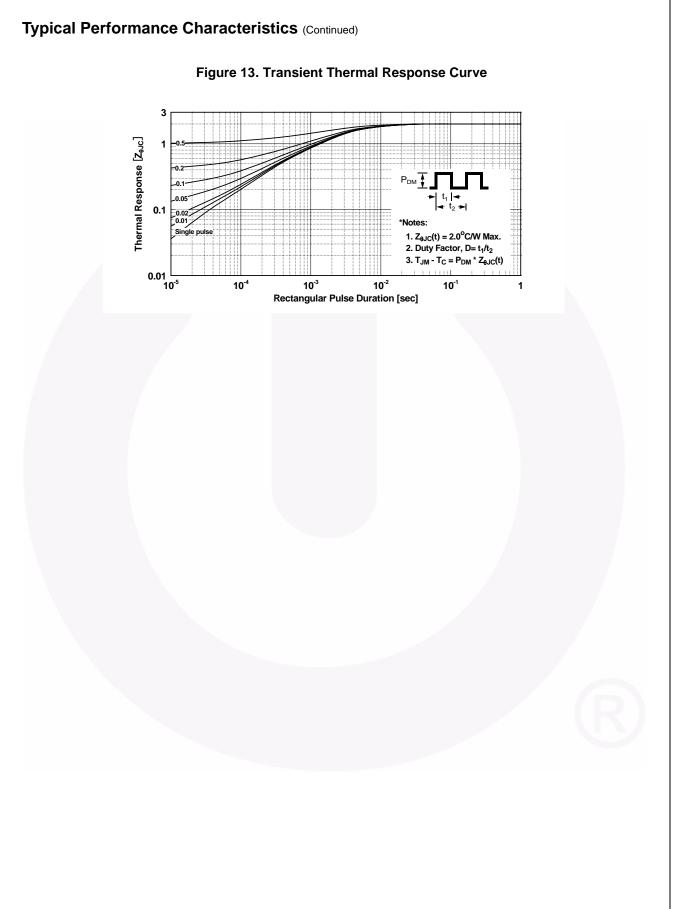
4. Essentially Independent of Operating Temperature Typical Characteristics

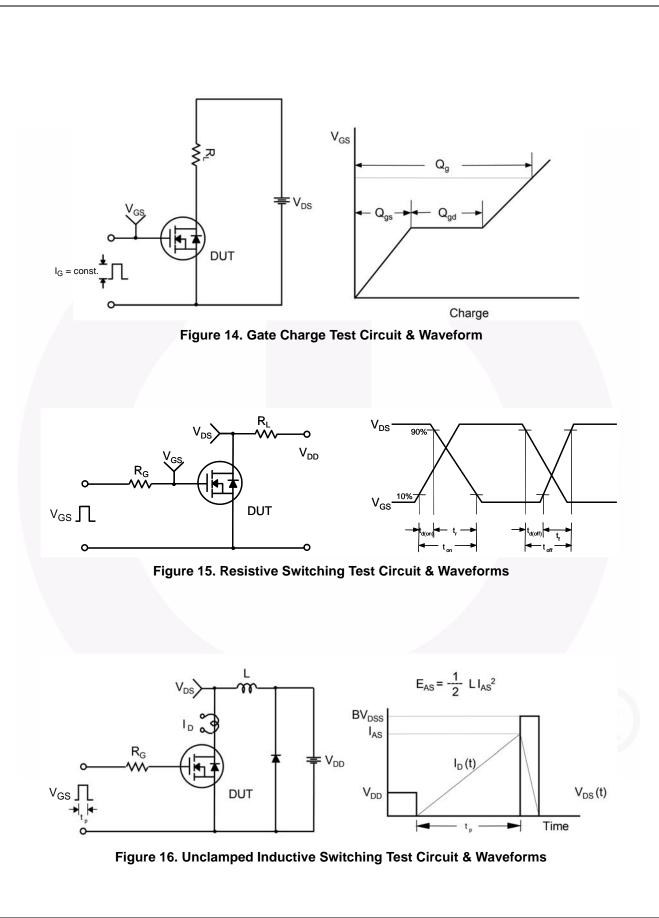


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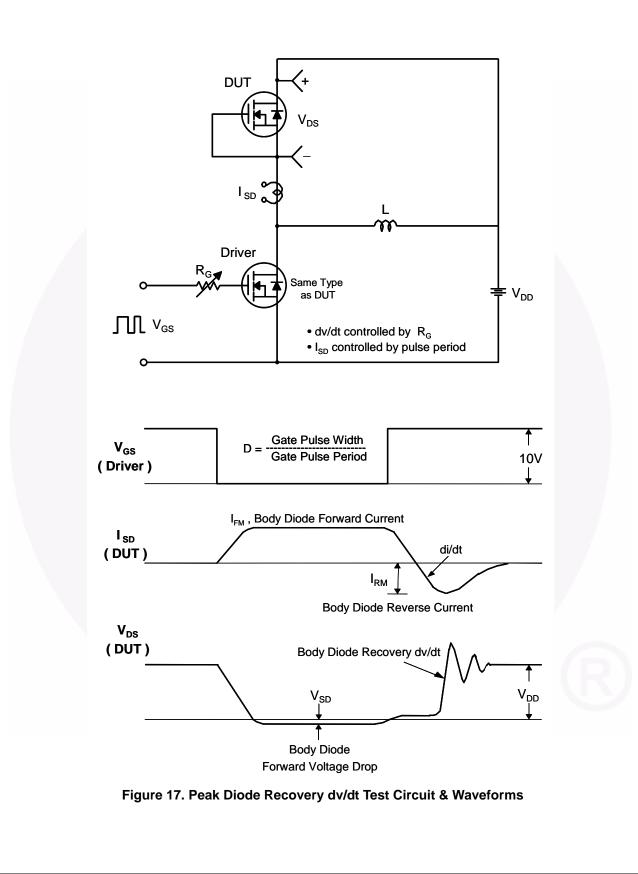
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